

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	FIRST SUPPLEMENTAL PATENT SECURITY AGREEMENT
CONVEYING PARTY DATA	
Name	Execution Date
DATA DEVICE CORPORATION	06/01/2009
RECEIVING PARTY DATA	
Name:	UBS AG, STAMFORD BRANCH, as Collateral Agent
Street Address:	677 Washington Blvd.
City:	Stamford
State/Country:	CONNECTICUT
Postal Code:	06901
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	11491459
Application Number:	11700130
CORRESPONDENCE DATA	
Fax Number:	(714)755-8290
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	714-540-1235
Email:	ipdocket@lw.com, kristin.azcona@lw.com
Correspondent Name:	LATHAM & WATKINS LLP
Address Line 1:	650 Town Center Drive, 20th Floor
Address Line 4:	Costa Mesa, CALIFORNIA 92626
ATTORNEY DOCKET NUMBER:	036793-0008
NAME OF SUBMITTER:	Kristin J. Azcona
Total Attachments: 6 source=Data Device - Supp Patent Agreement#page1.tif source=Data Device - Supp Patent Agreement#page2.tif source=Data Device - Supp Patent Agreement#page3.tif	

OP \$80.00 11491459

500875999

**PATENT
 REEL: 022777 FRAME: 0101**

source=Data Device - Supp Patent Agreement#page4.tif
source=Data Device - Supp Patent Agreement#page5.tif
source=Data Device - Supp Patent Agreement#page6.tif

FIRST LIEN SUPPLEMENTAL PATENT SECURITY AGREEMENT

FIRST LIEN SUPPLEMENTAL PATENT SECURITY AGREEMENT, dated as of June 1, 2009, by Data Device Corporation, a Delaware corporation (the "Company") in favor of UBS AG, STAMFORD BRANCH, in its capacity as Collateral Agent pursuant to the Credit Agreement (as defined in the Security Agreement, defined below), as pledgee, assignee and secured party (the Collateral Agent, in such capacity and together with any successors in such capacity, the "Collateral Agent").

WHEREAS, the Company has, pursuant to that certain first lien security agreement dated as of August 24, 2005 (the "Security Agreement"; capitalized terms used but not defined herein having the meanings assigned to such terms in the Security Agreement), made by ILC INDUSTRIES, INC., a Delaware corporation (the "Borrower"), ILC HOLDINGS, INC., a Delaware corporation ("Holdings"), and THE GUARANTORS PARTY THERETO (together with Holdings, the "Guarantors") and the Collateral Agent, as pledgors, assignors and debtors (the Borrower, together with the Guarantors, in such capacities and together with any successors in such capacities, the "Pledgors," and each, a "Pledgor"), in favor of the Collateral Agent, granted to the Collateral Agent for the benefit of the respective Secured Parties a security interest in and to all of the right, title and interest of such Pledgor, in, to and under the Pledged Collateral, including with respect thereto, the Patents, as collateral security for the payment and performance in full when due of the Secured Obligations;

WHEREAS, the Company, ILC Dover IP, Inc., a Delaware Corporation, and the Collateral Agent have entered into a first lien patent security agreement dated as of June 28, 2006 (the "First Lien Patent Security Agreement");

WHEREAS, the Company has acquired the additional patent applications set forth on Schedule A attached hereto; and

WHEREAS, the Company and the Collateral Agent wish to further memorialize the security interest described above as it relates to the patent applications identified in Schedule A hereto, and any renewals, reissues, continuations, continuations-in-part, divisionals, extensions and re-examinations thereof, and incorporated herein by this reference, and all other rights appurtenant thereto, including but not limited to, all products and proceeds thereof.

NOW THEREFORE, for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged and it being expressly understood and agreed that the security interests granted herein for the benefit of the Collateral Agent on behalf of the respective Secured Parties shall be subject to the subordination terms of the Credit Agreement, the following security interest is hereby granted: as security for the payment or performance, as the case may be, in full of the Obligations, the Company hereby pledges and grants to the Collateral Agent and its successors and assigns a first priority security interest in, all of the Company's right, title and interest in, to and under the patent applications identified in Schedule A.

(Signature page follows)

IN WITNESS WHEREOF, the Company has executed this First Lien
Supplemental Patent Security Agreement as an instrument as of the date first written above.

DATA DEVICE CORPORATION

By: _____

Name: _____

Title: _____

Kenneth J. Sheedy

Kenneth J. Sheedy

Vice President Finance

PATENT

REEL: 022777 FRAME: 0105

ACKNOWLEDGMENT OF PLEDGOR

STATE OF New York)
) ss.
COUNTY OF SUFFOLK)

On this 1st day of June, 2009 before me personally appeared Kenneth J. Sheedy, proved to me on the basis of satisfactory evidence to be the person who executed the foregoing instrument on behalf of Data Device Corporation who being by me duly sworn did depose and say that he is an authorized officer of said corporation, that the said instrument was signed on behalf of said corporation as authorized by its Board of Directors and that he acknowledged said instrument to be the free act and deed of said corporation.

Leanne L. Willmer
Notary Public

{seal}

LEANNE L. WILLMER
NOTARY PUBLIC, State of New York
No. 4771964
QUALIFIED IN SUFFOLK COUNTY
COMMISSION EXPIRES 8-31-2010

Acknowledged and Agreed:

UBS AG, STAMFORD BRANCH,
as Collateral Agent

By: Mary E. Evans

Name: Mary E. Evans

Title: Associate Director

By: Irja R. Otsa

Name: Irja R. Otsa

Title: Associate Director

SCHEDULE A
to
FIRST LIEN SUPPLEMENTAL PATENT SECURITY AGREEMENT

PATENTS:

Applications:

Owner	Application Number	Application Date	Country	Title
Data Device Corporation	11/491,459	07/21/2006	United States	<i>Predictive Signal Cancellation for Extracting 9MB/s MIL-STD-1553 Component from Composite High Performance 1553 Signal</i>
Data Device Corporation	11/700,130	01/31/2007	United States	<i>Multi-dimensional Burst Link Access Streaming Transmission (BLAST) Architecture and Algorithms for Low Latency RealTime Broadband Burst Data/Video Transmission</i>